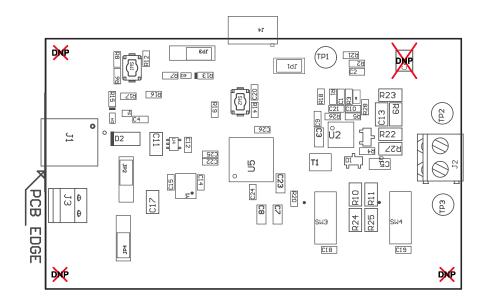
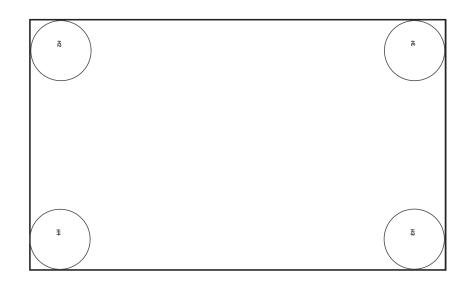
- ZZ2 These assemblies are ESD sensitive, ESD precautions shall be observed.
- These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: AIPO41	REV: A	SUN REV	: Not In VersionControl
IGNORE ->				
PLOT NAME = Top Assembly Drawing	GENERATED : 3/27/2	2015 2: 34: 55	PM	TEXAS INSTRUMENTS



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: AIPO41	REV: A	SVN REV: Not In VersionControl			
	IGNORE ->					
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/27/2	2015 2:34:56	PM TEXA	S INSTRUMENTS		

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